

SIPMOS® Power Transistor

- N channel
- Enhancement mode
- Logic Level
- Avalanche-rated
- dv/dt rated
- 175°C operating temperature
- also in SMD available



Pin 1	Pin 2	Pin 3
G	D	S

Type	V _{DS}	I _D	R _{DS(on)}	Package	Ordering Code
BUZ 101 SL	55 V	20 A	0.07 Ω	TO-220 AB	Q67040-S4012-A2

Maximum Ratings

Parameter	Symbol	Values	Unit
Continuous drain current <i>T_C</i> = 25 °C <i>T_C</i> = 100 °C	<i>I_D</i>	20 14	A
Pulsed drain current <i>T_C</i> = 25 °C	<i>I_{Dpuls}</i>	80	
Avalanche energy, single pulse <i>I_D</i> = 20 A, <i>V_{DD}</i> = 25 V, <i>R_{GS}</i> = 25 Ω <i>L</i> = 450 μH, <i>T_j</i> = 25 °C	<i>E_{AS}</i>	90	mJ
Avalanche current, limited by <i>T_{jmax}</i>	<i>I_{AR}</i>	20	A
Avalanche energy, periodic limited by <i>T_{jmax}</i>	<i>E_{AR}</i>	5.5	mJ
Reverse diode dv/dt <i>I_S</i> = 20 A, <i>V_{DS}</i> = 40 V, <i>di_F/dt</i> = 200 A/μs <i>T_{jmax}</i> = 175 °C	dv/dt	6	kV/μs
Gate source voltage	<i>V_{GS}</i>	± 14	V
Power dissipation <i>T_C</i> = 25 °C	<i>P_{tot}</i>	55	W

Maximum Ratings

Parameter	Symbol	Values	Unit
Operating temperature	T_j	-55 ... + 175	°C
Storage temperature	T_{stg}	-55 ... + 175	
Thermal resistance, junction - case	R_{thJC}	≤ 2.7	K/W
Thermal resistance, junction - ambient	R_{thJA}	≤ 62	
IEC climatic category, DIN IEC 68-1		55 / 175 / 56	

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static Characteristics

Drain- source breakdown voltage $V_{GS} = 0 \text{ V}, I_D = 0.25 \text{ mA}, T_j = 25 \text{ }^\circ\text{C}$	$V_{(BR)DSS}$	55	-	-	V
Gate threshold voltage $V_{GS}=V_{DS}, I_D = 40 \text{ }\mu\text{A}$	$V_{GS(th)}$	1.2	1.6	2	
Zero gate voltage drain current $V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, T_j = -40 \text{ }^\circ\text{C}$ $V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 25 \text{ }^\circ\text{C}$ $V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, T_j = 150 \text{ }^\circ\text{C}$	I_{DSS}	-	-	0.1 1 100	μA
Gate-source leakage current $V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$	I_{GSS}	-	10	100	
Drain-Source on-resistance $V_{GS} = 4.5 \text{ V}, I_D = 14 \text{ A}$ $V_{GS} = 10 \text{ V}, I_D = 14 \text{ A}$	$R_{DS(on)}$	-	0.057 0.034	0.07 0.04	

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

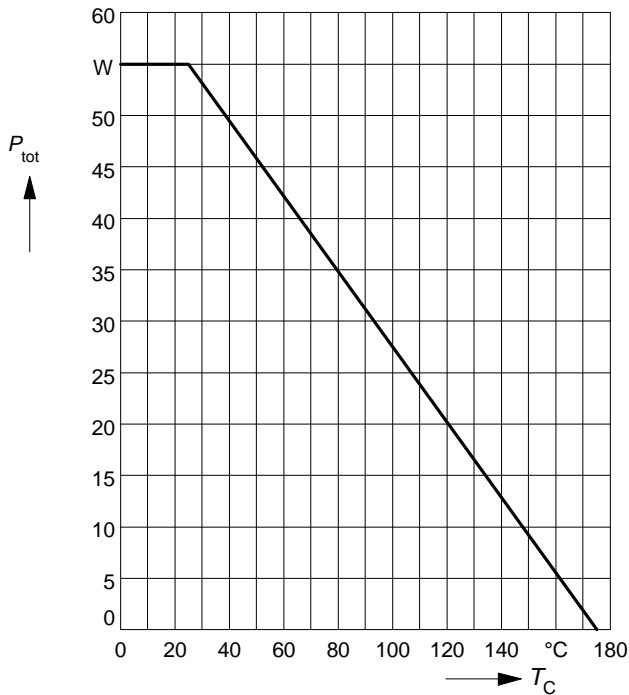
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Dynamic Characteristics					
Transconductance $V_{DS} \geq 2 \cdot I_D \cdot R_{DS(on)max}$, $I_D = 14 \text{ A}$	g_{fs}	7	14	-	S
Input capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{iss}	-	560	700	pF
Output capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{oss}	-	170	215	
Reverse transfer capacitance $V_{GS} = 0 \text{ V}$, $V_{DS} = 25 \text{ V}$, $f = 1 \text{ MHz}$	C_{rss}	-	95	120	
Turn-on delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 20 \text{ A}$ $R_G = 10 \Omega$	$t_{d(on)}$	-	15	25	ns
Rise time $V_{DD} = 30 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 20 \text{ A}$ $R_G = 10 \Omega$	t_r	-	35	55	
Turn-off delay time $V_{DD} = 30 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 20 \text{ A}$ $R_G = 10 \Omega$	$t_{d(off)}$	-	15	25	
Fall time $V_{DD} = 30 \text{ V}$, $V_{GS} = 4.5 \text{ V}$, $I_D = 20 \text{ A}$ $R_G = 10 \Omega$	t_f	-	15	25	
Gate charge at threshold $V_{DD} = 40 \text{ V}$, $I_D \geq 0.1 \text{ A}$, $V_{GS} = 0 \text{ to } 1 \text{ V}$	$Q_{g(th)}$	-	0.8	1.2	nC
Gate charge at 5.0 V $V_{DD} = 40 \text{ V}$, $I_D = 20 \text{ A}$, $V_{GS} = 0 \text{ to } 5 \text{ V}$	$Q_{g(5)}$	-	15	23	
Gate charge total $V_{DD} = 40 \text{ V}$, $I_D = 20 \text{ A}$, $V_{GS} = 0 \text{ to } 10 \text{ V}$	$Q_{g(total)}$	-	24	36	
Gate plateau voltage $V_{DD} = 40 \text{ V}$, $I_D = 20 \text{ A}$	$V_{(plateau)}$	-	4.06	-	V

Electrical Characteristics, at $T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Reverse Diode					
Inverse diode continuous forward current $T_C = 25^\circ\text{C}$	I_S	-	-	20	A
Inverse diode direct current, pulsed $T_C = 25^\circ\text{C}$	I_{SM}	-	-	80	
Inverse diode forward voltage $V_{GS} = 0\text{ V}, I_F = 40\text{ A}$	V_{SD}	-	1.12	1.8	V
Reverse recovery time $V_R = 30\text{ V}, I_F = I_S, di_F/dt = 100\text{ A}/\mu\text{s}$	t_{rr}	-	50	75	ns
Reverse recovery charge $V_R = 30\text{ V}, I_F = I_S, di_F/dt = 100\text{ A}/\mu\text{s}$	Q_{rr}	-	0.12	0.18	μC

Power dissipation

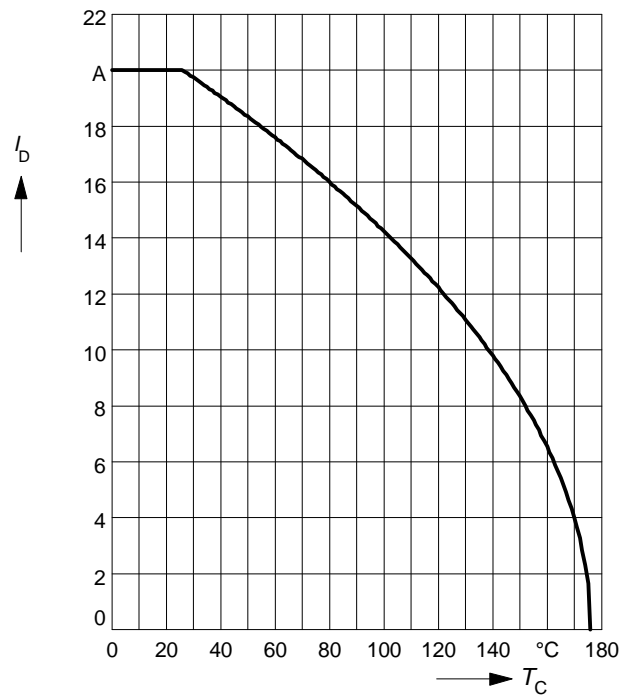
$$P_{\text{tot}} = f(T_C)$$



Drain current

$$I_D = f(T_C)$$

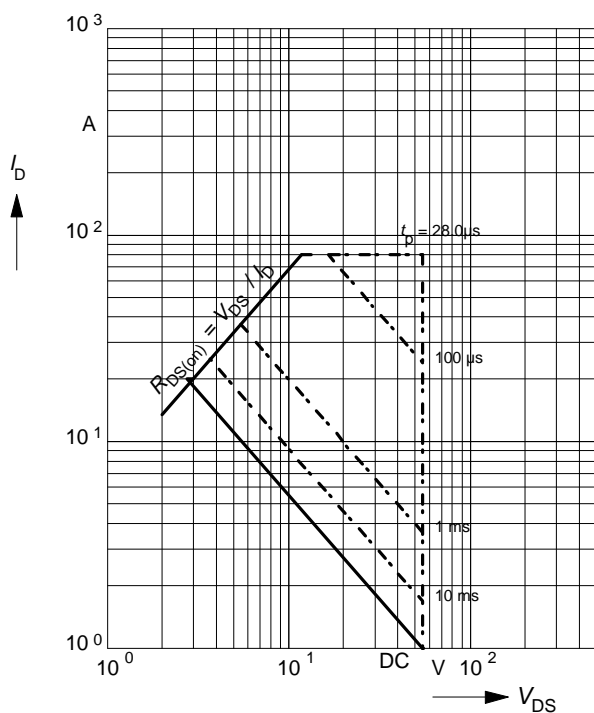
parameter: $V_{GS} \geq 4 \text{ V}$



Safe operating area

$$I_D = f(V_{DS})$$

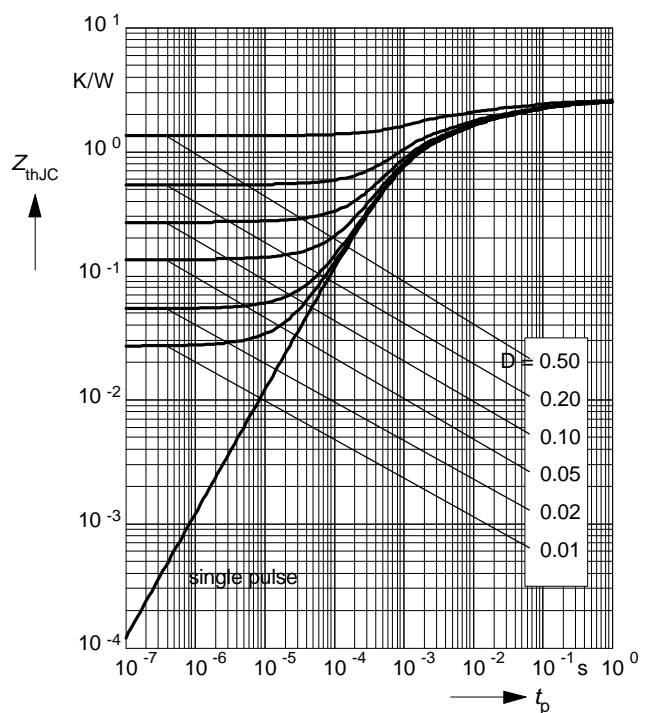
parameter: $D = 0.01$, $T_C = 25^\circ\text{C}$



Transient thermal impedance

$$Z_{\text{thJC}} = f(t_p)$$

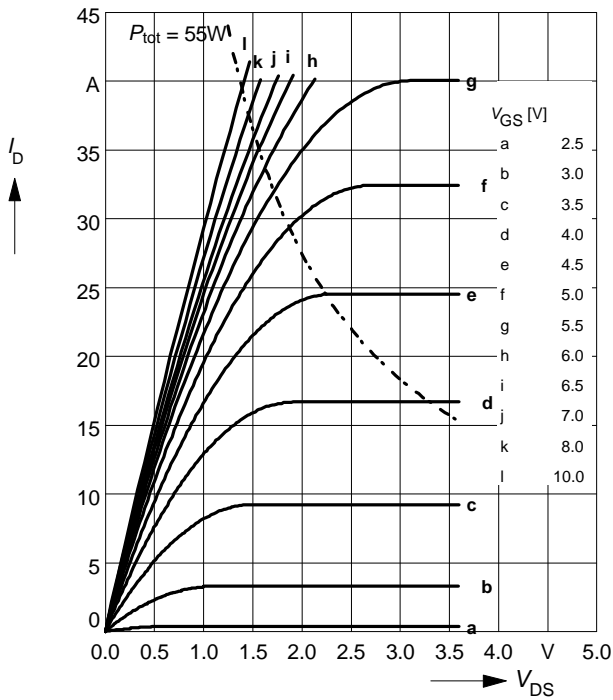
parameter: $D = t_p / T$



Typ. output characteristics

$$I_D = f(V_{DS})$$

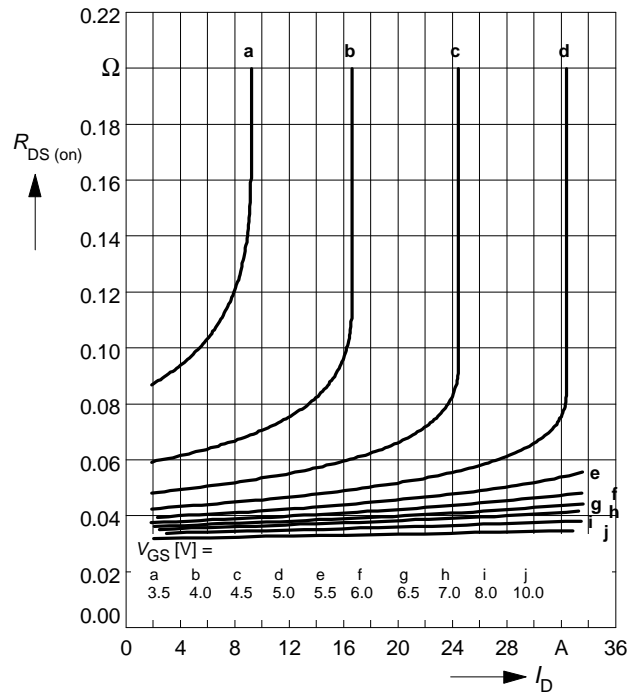
parameter: $t_p = 80 \mu s$, $T_j = 25^\circ C$



Typ. drain-source on-resistance

$$R_{DS(on)} = f(I_D)$$

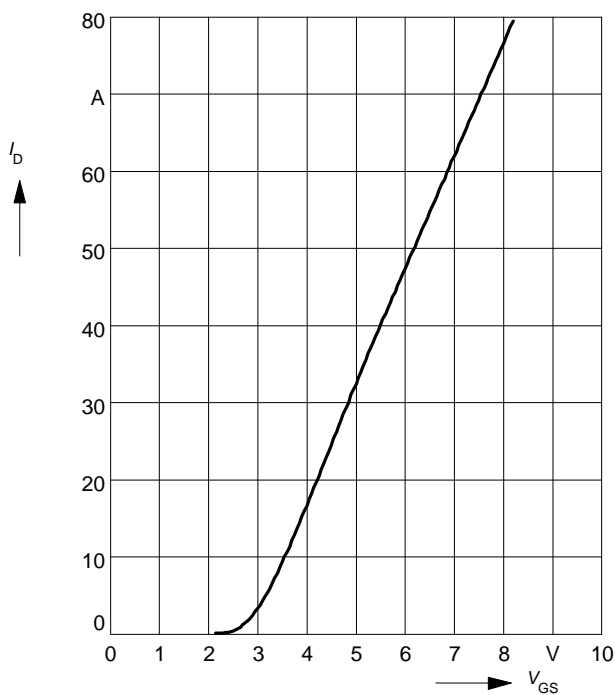
parameter: $t_p = 80 \mu s$, $T_j = 25^\circ C$



Typ. transfer characteristics $I_D = f(V_{GS})$

parameter: $t_p = 80 \mu s$

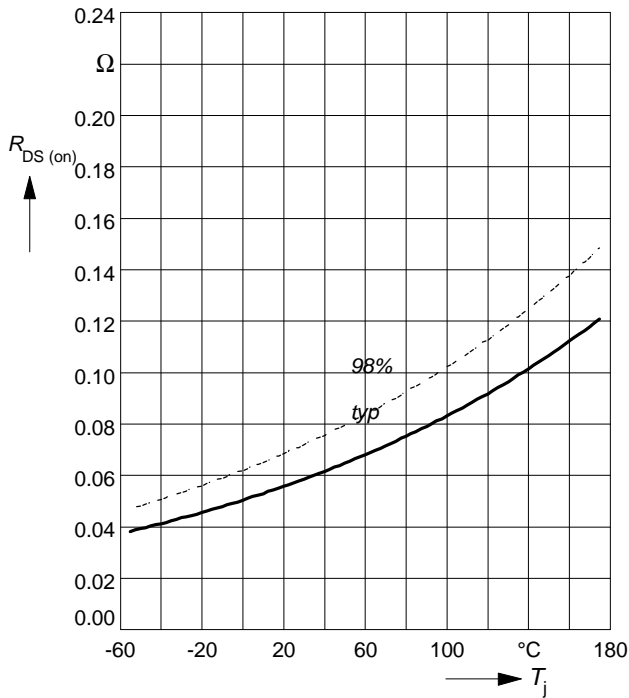
$$V_{DS} \geq 2 \times I_D \times R_{DS(on)max}$$



Drain-source on-resistance

$$R_{DS(on)} = f(T_j)$$

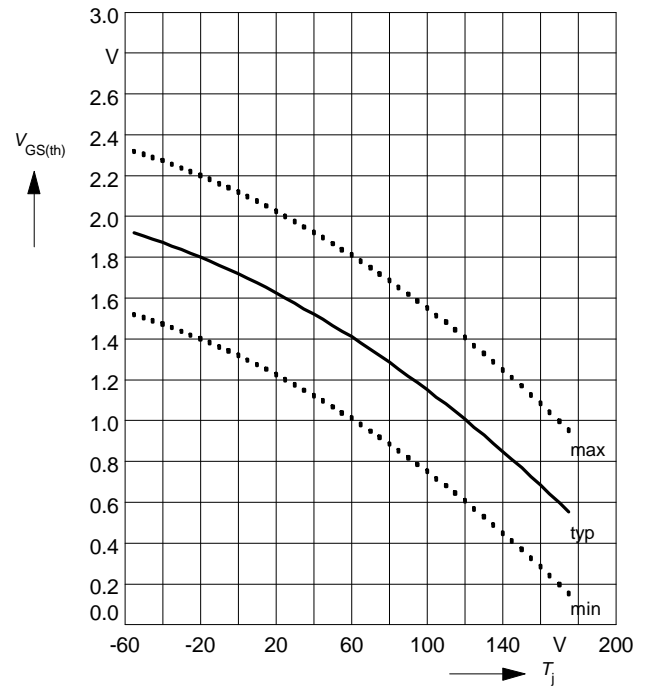
parameter: $I_D = 14 \text{ A}$, $V_{GS} = 4.5 \text{ V}$



Gate threshold voltage

$$V_{GS(th)} = f(T_j)$$

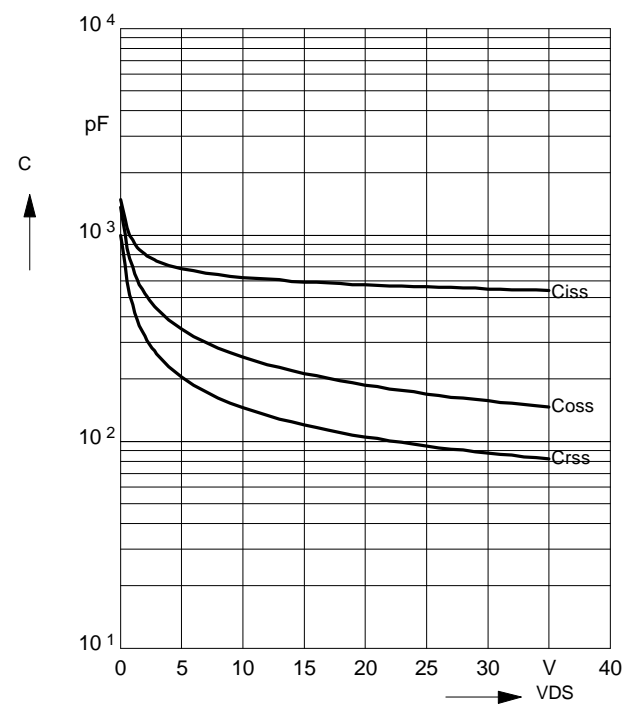
parameter: $V_{GS} = V_{DS}$, $I_D = 40 \mu\text{A}$



Typ. capacitances

$$C = f(V_{DS})$$

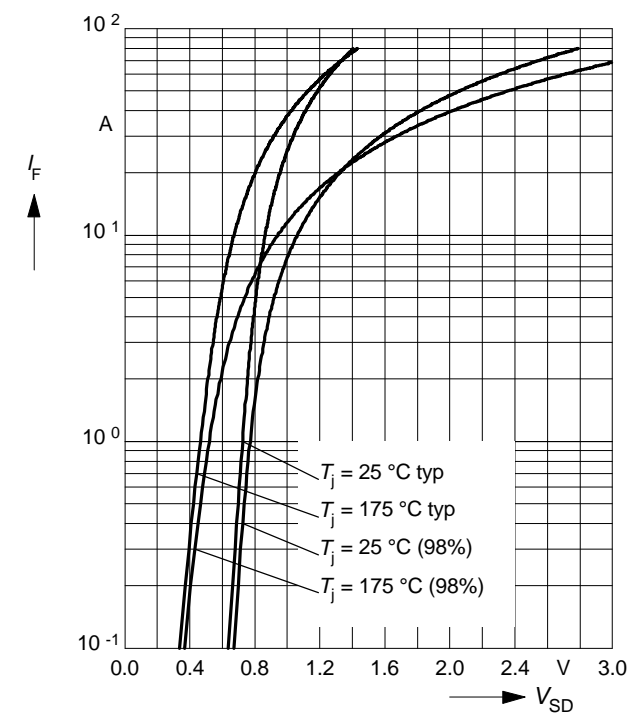
parameter: $V_{GS} = 0 \text{ V}$, $f = 1 \text{ MHz}$



Forward characteristics of reverse diode

$$I_F = f(V_{SD})$$

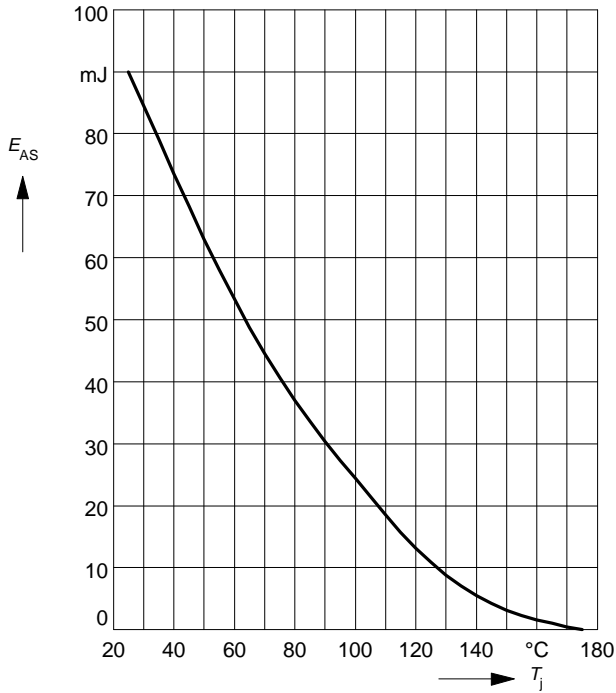
parameter: T_j , $t_p = 80 \mu\text{s}$



Avalanche energy $E_{AS} = f(T_j)$

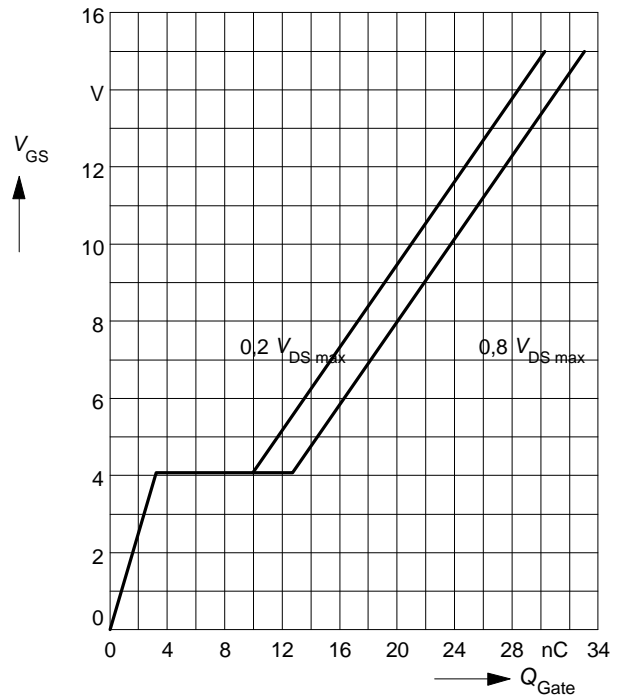
parameter: $I_D=20A, V_{DD}=25V$

$R_{GS}=25\ \Omega, L=450\mu H$



Typ. gate charge $V_{GS} = f(Q_{Gate})$

parameter: $I_{D\ puls} = 20\ A$



Drain-source breakdown voltage $V_{(BR)DSS} = f(T_j)$

